

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10074888			
<b>Filing Date:</b>	13-Feb-2002			
<b>Title of Invention:</b>	REDUCING DEFECT FORMATION WITHIN AN ETCHED SEMICONDUCTOR TOPOGRAPHY			
<b>First Named Inventor:</b>	Benjamin C.E. Schwarz			
<b>Filer:</b>	Mollie E. Lettang/Pamela Gerik			
<b>Attorney Docket Number:</b>	5298-06900 PM01027			
Filed as Large Entity				
<b>Utility</b>	<b>Filing Fees</b>			
<b>Description</b>	<b>Fee Code</b>	<b>Quantity</b>	<b>Amount</b>	<b>Sub-Total in USD(\$)</b>
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
Post-Allowance-and-Post-Issuance:				
Utility Appl issue fee	1501	1	1400	1400
<b>Extension-of-Time:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				1400